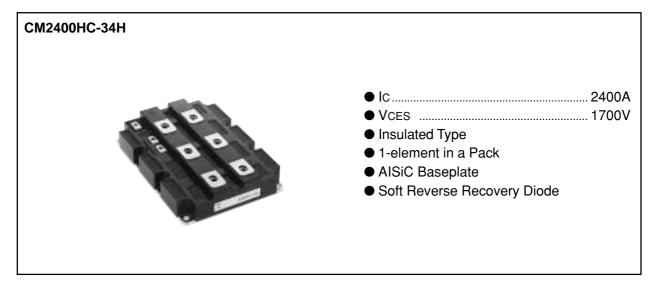
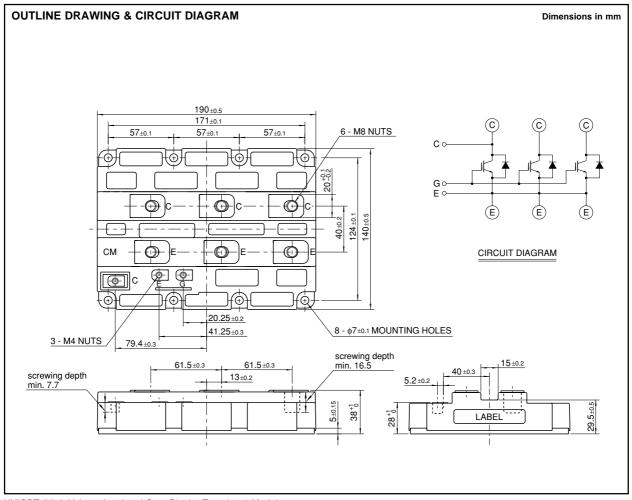
HIGH POWER SWITCHING USE
INSULATED TYPE

3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers





HIGH POWER SWITCHING USE INSULATED TYPE

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MAXIMUM RATINGS

Symbol	Item	Conditions		Ratings	Unit
VCES	Collector-emitter voltage	VGE = 0V, Tj = 25°C		1700	V
VGES	Gate-emitter voltage	VCE = 0V, Tj = 25°C		±20	V
Ic	Collector current	Tc = 80°C		2400	Α
Ісм	Collector current	Pulse	(Note 1)	4800	Α
IE (Note 2)	Emitter current			2400	Α
IEM (Note 2)	Emiller current	Pulse	(Note 1)	4800	Α
PC (Note 3)	Maximum power dissipation	Tc = 25°C, IGBT part		17800	W
Tj	Junction temperature			− 40 ~ +150	°C
Тор	Operating temperature			− 40 ~ +125	°C
Tstg	Storage temperature			− 40 ~ +125	°C
Viso	Isolation voltage	RMS, sinusoidal, f = 60Hz, t = 1min.		4000	V
tpsc	Maximum short circuit pulse width	Vcc = 1150V, VcEs ≤ 1700V, VGE = 15V Tj = 125°C		10	μs

ELECTRICAL CHARACTERISTICS

Symbol	Item	Conditions		Limits		Unit	
		Conditions		Min	Тур	Max	Offic
ICES	Collector cut-off current	VCE = VCES, VGE = 0V, Tj = 25°C		_	_	36	mA
VGE(th)	Gate-emitter threshold voltage	IC = 240mA, VCE = 10V, Tj = 25°C		4.5	5.5	6.5	٧
IGES	Gate leakage current	VGE = VGES, VCE = 0V, Tj = 25°C		_	_	0.5	μА
Va=()	Collector-emitter	IC = 2400A, VGE = 15V, Tj = 25°C (N	Note 4)	_	2.60	3.30	
VCE(sat)	saturation voltage	IC = 2400A, VGE = 15V, Tj = 125°C (N	Note 4)	_	3.10	_	- V
Cies	Input capacitance	\\c= 40\\ \\ 400\\ \ -		_	210	_	nF
Coes	Output capacitance	VCE = 10V, f = 100kHz	[_	30.0	_	nF
Cres	Reverse transfer capacitance	VGE = 0V, Tj = 25°C		_	10.1	_	nF
Qg	Total gate charge	VCC = 850V, IC = 2400A, VGE = 15V, Tj = 25°C		_	19.8	_	μC
VEC (Note 2)	Emitter-collector voltage	$IE = 2400A$, $VGE = 0V$, $T_j = 25^{\circ}C$ (N	Note 4)	_	2.30	3.00	V
VEC (Note 2)		$IE = 2400A$, $VGE = 0V$, $T_j = 125$ °C (N	Note 4)	_	1.85	_	
td(on)	Turn-on delay time	VCC = 850V, IC = 2400A, VGE = ±15V		_	_	1.60	μs
tr	Turn-on rise time	RG(on) = 0.27Ω , Tj = 125° C, Ls = 80 nH			_	1.30	μs
Eon	Turn-on switching energy	Inductive load		_	810	_	mJ/pulse
td(off)	Turn-off delay time	Vcc = 850V, Ic = 2400A, VgE = ±15V		_	_	2.70	μs
tf	Turn-off fall time	RG(off) = 0.27Ω , Tj = 125° C, Ls = 80 nH			_	0.80	μs
Eoff	Turn-off switching energy	Inductive load		_	870	_	mJ/pulse
trr (Note 2)	Reverse recovery time	VCC = 850V, IC = 2400A, VGE = ±15V			_	2.70	μs
Qrr (Note 2)	Reverse recovery charge	RG(on) = 0.27Ω , Tj = 125° C, Ls = 80 nH	Ī	_	630		μС
Erec (Note 2)	Reverse recovery energy	Inductive load		_	330	_	mJ/pulse

Note 1. Pulse width and repetition rate should be such that junction temperature (Tj) does not exceed Topmax rating (125°C).

2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).

3. Junction temperature (Tj) should not exceed Tjmax rating (150°C).

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.



HIGH POWER SWITCHING USE INSULATED TYPE

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THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
		Conditions	Min	Тур	Max	Unit
Rth(j-c)Q	Thermal resistance	Junction to Case, IGBT part	_	_	7.0	K/kW
Rth(j-c)R		Junction to Case, FWDi part	_	_	12.0	K/kW
Rth(c-f)	Contact thermal resistance	Case to Fin, λgrease = 1W/m·K	_	6.0	_	K/kW

MECHANICAL CHARACTERISTICS

Symbol	Item	O a malifelia ma		Limits		Limit
		Conditions	Min	Тур	Max	Unit
М	Mounting torque	M8 : Main terminals screw	7.0		13.0	N·m
		M6 : Mounting screw	3.0	_	6.0	
		M4 : Auxiliary terminals screw	1.0		2.0	
_	Mass		_	1.5	_	kg
CTI	Comparative tracking index		600	1	1	_
da	Clearance distance in air		19.5		_	mm
ds	Creepage distance along surface		32.0		_	mm
LC-E(int)	Internal inductance	IGBT part		10	_	nΗ

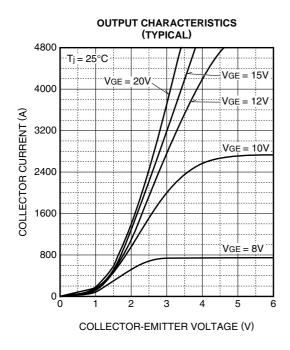


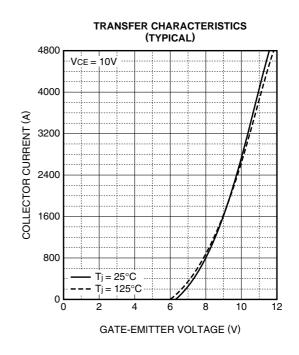
INSULATED TYPE

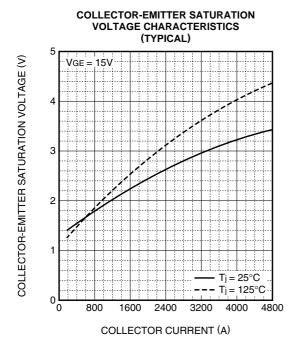
HIGH POWER SWITCHING USE

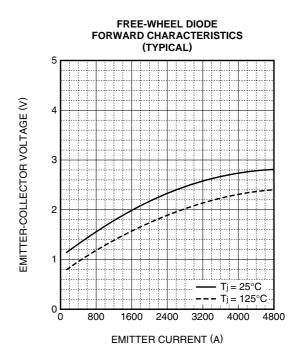
3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

PERFORMANCE CURVES





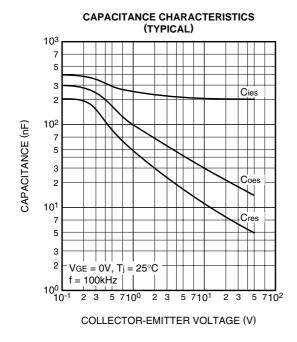


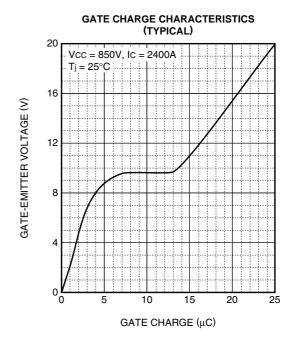


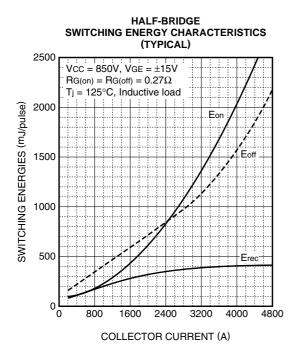


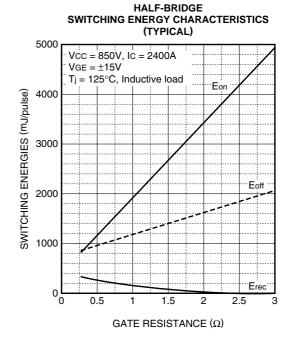
HIGH POWER SWITCHING USE INSULATED TYPE

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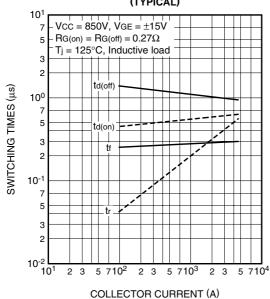




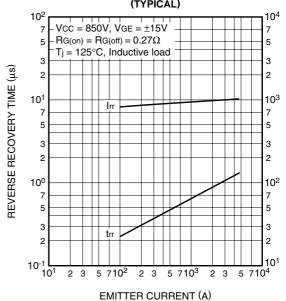
REVERSE RECOVERY CURRENT (A)

HIGH POWER SWITCHING USE INSULATED TYPE

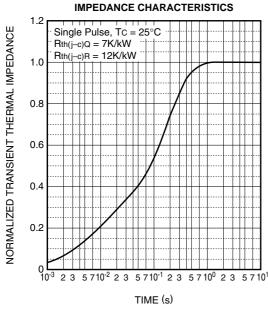
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



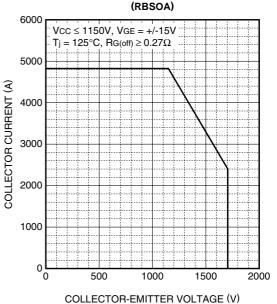
FREE-WHEEL DIODE
REVERSE RECOVERY CHARACTERISTICS
(TYPICAL)



TRANSIENT THERMAL



REVERSE BIAS SAFE OPERATING AREA





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